S101D01/S101D02 S201D01/S201D02

Features

1. Compact

(16-pin dual-in-line package type)

- 2. RMS ON-state current I_T: 1.2Arms
- 3. Built-in zero-cross circuit

(S101D02, S201D02)

- 4. Recognised by UL, file No. E94758
- 5. Approved by CSA, No. LR63705

Applications

- 1. Fan heaters
- 2. Microwave ovens
- 3. Refrigerators
- 4. Air conditioners

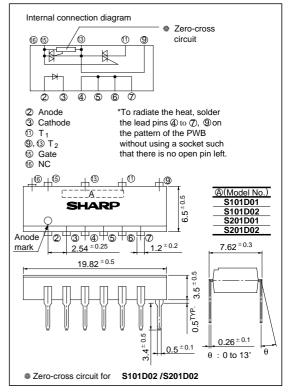
Model Line-ups

	For 100V	For 200V	
	lines	lines	
For phase control			
No built-in zero-	S101D01	S201D01	
cross circuit			
Built-in zero-	S101D02	S201D02	
cross circuit	3101002		

16-Pin DIP Type SSR for Low Power Control

Outline Dimensions

(Unit: mm)



Absolute Maximum Ratings

$(Ta = 25^{\circ}C)$

Parameter		Symbol	Rating		TT :
			S101D01/S101D02	S201D01/S201D02	Unit
Input	Forward current	$I_{\rm F}$	50		mA
Input	Reverse voltage	VR	6		V
Output	RMS ON-state current	IT	1.2		A rms
	*1Peak one cycle surge current	I surge	12		А
	Repetitive peak OFF-state voltage	V DRM	400	600	V
*2Isolation voltage		V iso	4 000		V rms
Operating temperature		T opr	- 25 to + 85		°C
Storage temperature		T stg	- 40 to + 125		°C
*3Soldering temperature		T sol	260		°C

*1 50Hz, sine wave

*2 40 to 60% RH, AC 60Hz for 1 minute

*3 For 10 seconds

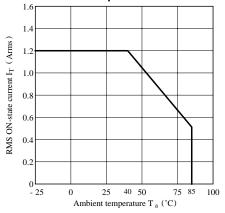
" In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device."

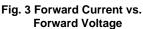
Parameter Symbol Conditions MIN. TYP. MAX Unit $I_F = 20mA$ Forward voltage VF _ 1.2 1.4 v Input Reverse current I_R $V_R = 3V$ 10^{-5} Α _ _ Repetitive S101D01 / S101D02 $V_{DRM} = 400V$ _ 10^{-4} А _ I drm peak OFF-state S201D01 / S201D02 $V_{DRM} = 600V$ 10-4 Α current _ _ ON-state voltage Vт $I_{T} = 1.2A$ 1.7 v _ _ Holding current $V_D = 6V$ 25 Output \mathbf{I}_{H} mA _ -Vox Zero-cross voltage S101D02 / S201D02 Resistance load, $I_F = 15 \text{mA}$ 35 v _ Critical rate of S101D01 / S101D02 $V_{DRM} = 1/\sqrt{2} \cdot 400V$ 200 _ V/µ s _ dV/dt rise of OFF-state S201D01 / S201D02 $V_{DRM} = 1/\sqrt{2} \cdot 600V$ 100 $V/\mu s$ _ _ voltage Minimum trigger current $V_{\rm D} = 6V, R_{\rm L} = 100\Omega$ 10 $I_{\,\rm FT}$ mA _ _ Transfer Isolation resistance DC500V, 40 to 60% RH 5 x 1010 10^{11} charac-R iso Ω _ teristics $V_{\rm D} = 6V, R_{\rm L} = 100\Omega, I_{\rm F} = 20mA$ 100 Turn-on time t on μs

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Fig. 1	RMS ON-state Current vs.
-	Ambient Temperature





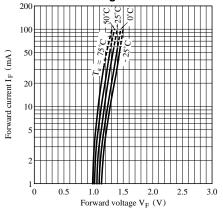


Fig. 2 Forward Current vs. Ambient Temperature

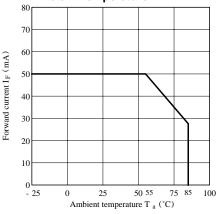
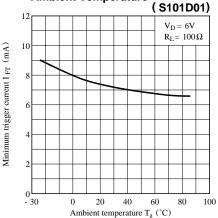
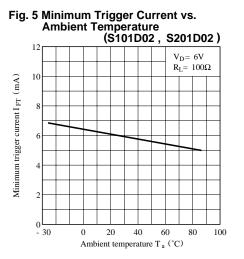
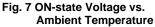
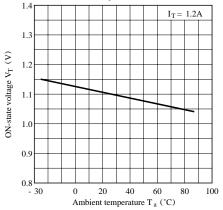


Fig. 4 Minimum Trigger Current vs. Ambient Temperature











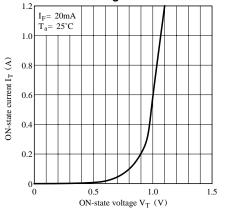


Fig. 6 Minimum Trigger Current vs. Ambient Temperature

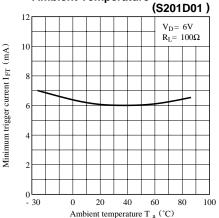


Fig. 8 Relative Holding Current vs. Ambient Temperature

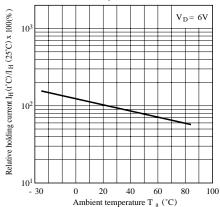
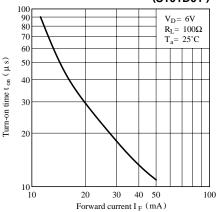


Fig.10 Turn-on Time vs. Forward Current (S101D01)



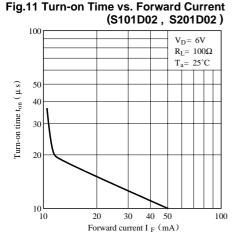
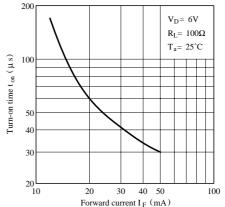
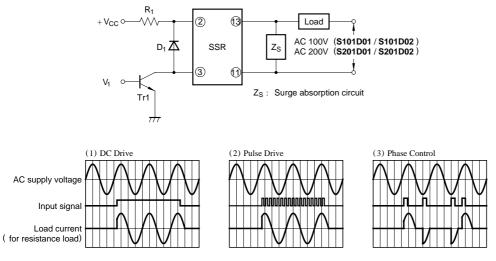


Fig.12 Turn-on Time vs. Forward Current (S201D01)



Basic Operation Circuit



Notes 1) If large amount of surge is loaded onto V $_{\rm CC}$ or the driver circuit, add a diode D $_1$ between terminals 2 and 3 to prevent reverse bias from being applied to the infrared LED.

Be sure to install a surge absorption circuit.
An appropriate circuit must be chosen according to the load (for CR, choose its constant). This must be carefully done especially for an inductive load.

3) For phase control, adjust such that the load current immediately after the input signal is applied will be more than 60mA.

(Precautions for Use)

- 1) All pins must be soldered since they are also used as heat sinks (heat radiation fins). In designing, take into the heat radiation from the mounted SSR.
- 2) For higher radiation efficiency that allows wider thermal margin, secure a wider round pattern for Pin 13 when designing mounting pattern. The rounded part of Pin 15 (gate) must be as small as possible. Pulling the gate pattern around increases the change of being affected by external noise.
- 3) As for other general cautions, refer to the chapter "Precautions for Use"

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 - Test and measurement equipment
 - Industrial control
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 - Consumer electronics

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- Alarm equipment
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